## Dual Digitally-Controlled (XDCP ${ }^{\text {™ }}$ ) Potentiometers

## FEATURES

- Dual-Two Separate Potentiometers
- 256 Resistor Taps/pot-0.4\% Resolution
- SPI Serial Interface for Write, Read, and Transfer Operations of the Potentiometer
- Wiper Resistance, $100 \Omega$ typical @ V+ = 5V, V- = -5V
- 4 Nonvolatile Data Registers for Each Potentiometer
- Nonvolatile Storage of Multiple Wiper Positions
- Power-on Recall. Loads Saved Wiper Position on Power-up.
- Standby Current <5 A A Max
- $\mathrm{V}_{\mathrm{Cc}}: 2.7 \mathrm{~V}$ to 5.5 V Operation
- $50 \mathrm{k} \Omega, 100 \mathrm{k} \Omega$ Versions of End to End Resistance
- 100 yr. Data Retention
- Endurance: 100,000 Data Changes per Bit per Register
- 24 Ld SOIC
- Low Power CMOS
- Power Supply $\mathrm{V}_{\mathrm{CC}}=2.7 \mathrm{~V}$ to 5.5 V
$\mathrm{V}+=2.7 \mathrm{~V}$ to 5.5 V
V - = -2.7V to -5.5V
- Pb-Free Plus Anneal Available (RoHS Compliant)


## DESCRIPTION

The X9260 integrates 2 digitally controlled potentiometer (XDCP) on a monolithic CMOS integrated circuit.

The digitally controlled potentiometer is implemented using 255 resistive elements in a series array. Between each element are tap points connected to the wiper terminal through switches. The position of the wiper on the array is controlled by the user through the SPI bus interface. Each potentiometer has associated with it a volatile Wiper Counter Register (WCR) and a four nononvolatile Data Registers that can be directly written to and read by the user. The contents of the WCR controls the position of the wiper on the resistor array though the switches. Power-up recalls the contents of the default Data Register (DR0) to the WCR.

The XDCP can be used as a three-terminal potentiometer or as a two terminal variable resistor in a wide variety of applications including control, parameter adjustments, and signal processing.

## FUNCTIONAL DIAGRAM



## Ordering Information

| PART NUMBER | PART MARKING | $\mathrm{V}_{\text {cc }}$ LIMITS (V) | POTENTIOMETER ORGANIZATION (k $\Omega$ ) | TEMPERATURE RANGE ( ${ }^{\circ} \mathrm{C}$ ) | PACKAGE | PKG. DWG. \# |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| X9260TS24I | X9260TS I | $5 \pm 10 \%$ | 100 | -40 to +85 | 24 Ld SOIC (300 mil) | M24.3 |
| X9260TS24IZ (Note) | X9260TS ZI |  |  | -40 to +85 | 24 Ld SOIC ( 300 mil ) (Pb-free) | M24.3 |
| X9260US24 | X9260US |  | 50 | 0 to +70 | 24 Ld SOIC (300 mil) | M24.3 |
| X9260US24Z (Note) | X9260US Z |  |  | 0 to +70 | 24 Ld SOIC ( 300 mil ) (Pb-free) | M24.3 |
| X9260TS24I-2.7 | X9260TS G | 2.7 to 5.5 | 100 | -40 to +85 | 24 Ld SOIC (300 mil) | M24.3 |
| X9260TS24IZ-2.7 (Note) | X9260TS ZG |  |  | -40 to +85 | 24 Ld SOIC ( 300 mil ) (Pb-free) | M24.3 |
| X9260US24-2.7 | X9260US F |  | 50 | 0 to +70 | 24 Ld SOIC (300 mil) | M24.3 |
| X9260US24Z-2.7 (Note) | X9260US ZF |  |  | 0 to +70 | 24 Ld SOIC ( 300 mil ) (Pb-free) | M24.3 |

*Add "T1" suffix for tape and reel.
NOTE: Intersil Pb-free plus anneal products employ special Pb-free material sets; molding compounds/die attach materials and $100 \%$ matte tin plate termination finish, which are RoHS compliant and compatible with both SnPb and Pb -free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

## DETAILED FUNCTIONAL DIAGRAM



## CIRCUIT LEVEL APPLICATIONS

- Vary the gain of a voltage amplifier
- Provide programmable dc reference voltages for comparators and detectors
- Control the volume in audio circuits
- Trim out the offset voltage error in a voltage amplifier circuit
- Set the output voltage of a voltage regulator
- Trim the resistance in Wheatstone bridge circuits
- Control the gain, characteristic frequency and Q-factor in filter circuits
- Set the scale factor and zero point in sensor signal conditioning circuits
- Vary the frequency and duty cycle of timer ICs
- Vary the dc biasing of a pin diode attenuator in RF circuits
- Provide a control variable (I, V, or R) in feedback circuits


## SYSTEM LEVEL APPLICATIONS

- Adjust the contrast in LCD displays
- Control the power level of LED transmitters in communication systems
- Set and regulate the DC biasing point in an RF power amplifier in wireless systems
- Control the gain in audio and home entertainment systems
- Provide the variable DC bias for tuners in RF wireless systems
- Set the operating points in temperature control systems
- Control the operating point for sensors in industrial systems
- Trim offset and gain errors in artificial intelligent systems


## PIN CONFIGURATION



## PIN ASSIGNMENTS

| $\begin{gathered} \text { Pin } \\ \text { (SOIC) } \end{gathered}$ | Symbol | Function |
| :---: | :---: | :---: |
| 1 | SO | Serial Data Output for SPI bus |
| 2 | A0 | Device Address for SPI bus. |
| 3 | NC | No Connect. |
| 4 | NC | No Connect. |
| 5 | NC | No Connect. |
| 6 | V+ | Analog Supply Voltage (Positive) |
| 7 | $\mathrm{V}_{\mathrm{CC}}$ | System Supply Voltage |
| 8 | $\mathrm{R}_{\mathrm{L} 0}$ | Low Terminal for Potentiometer 0. |
| 9 | $\mathrm{R}_{\mathrm{H} 0}$ | High Terminal for Potentiometer 0. |
| 10 | $\mathrm{R}_{\text {W0 }}$ | Wiper Terminal for Potentiometer 0. |
| 11 | CS | Device Address for SPI bus. |
| 12 | $\overline{\text { WP }}$ | Hardware Write Protect |
| 13 | SI | Serial Data Input for SPI bus |
| 14 | A1 | Device Address for SPI bus. |
| 15 | $\mathrm{R}_{\mathrm{L} 1}$ | Low Terminal for Potentiometer 1. |
| 16 | $\mathrm{R}_{\mathrm{H} 1}$ | High Terminal for Potentiometer 1. |
| 17 | $\mathrm{R}_{\mathrm{W} 1}$ | Wiper Terminal for Potentiometer 1. |
| 18 | $\mathrm{V}_{\text {SS }}$ | System Ground |
| 19 | V - | Analog Supply Voltage (Negative) |
| 20 | NC | No Connect |
| 21 | NC | No Connect |
| 22 | NC | No Connect |
| 23 | SCK | Serial Clock for SPI bus |
| 24 | HOLD | Device select. Pause the SPI serial bus. |

## PIN DESCRIPTIONS

## Bus Interface Pins

## SERIAL OUTPUT (SO)

SO is a serial data output pin. During a read cycle, data is shifted out on this pin. Data is clocked out by the falling edge of the serial clock.

## SERIAL INPUT

SI is the serial data input pin. All opcodes, byte addresses and data to be written to the pots and pot registers are input on this pin. Data is latched by the rising edge of the serial clock.

## SERIAL CLOCK (SCK)

The SCK input is used to clock data into and out of the X9260.

## HOLD ( $\overline{\text { HOLD }}$ )

$\overline{\text { HOLD }}$ is used in conjunction with the $\overline{\mathrm{CS}}$ pin to select the device. Once the part is selected and a serial sequence is underway, $\overline{H O L D}$ may be used to pause the serial communication with the controller without resetting the serial sequence. To pause, HOLD must be brought LOW while SCK is LOW. To resume communication, $\overline{\text { HOLD }}$ is brought HIGH, again while SCK is LOW. If the pause feature is not used, HOLD should be held HIGH at all times.

## DEVICE ADDRESS (A1 - A0)

The address inputs are used to set the 4-bit slave address. A match in the slave address serial data stream must be made with the address input in order to initiate communication with the X9260.

## CHIP SELECT (CS)

When $\overline{\mathrm{CS}}$ is HIGH, the X9260 is deselected and the SO pin is at high impedance, and (unless an internal write cycle is underway) the device will be in the
standby state. $\overline{\mathrm{CS}}$ LOW enables the X9260, placing it in the active power mode. It should be noted that after a power-up, a HIGH to LOW transition on $\overline{C S}$ is required prior to the start of any operation.

## Potentiometer Pins

## $\mathbf{R}_{\mathbf{H}}, \mathbf{R}_{\mathrm{L}}$

The $\mathrm{R}_{\mathrm{H}}$ and $\mathrm{R}_{\mathrm{L}}$ pins are equivalent to the terminal connections on a mechanical potentiometer. Since there are 2 potentiometers, there are 2 sets of $R_{H}$ and $R_{L}$ such that $R_{H O}$ and $R_{L O}$ are the terminals of POT 0 and so on.

## $\mathrm{R}_{\mathrm{W}}$

The wiper pin are equivalent to the wiper terminal of a mechanical potentiometer. Since there are 2 potentiometers, there are 2 sets of $R_{W}$ such that $R_{W 0}$ is the terminals of POT 0 and so on.

## Supply Pins

## SYSTEM SUPPLY VOLTAGE ( $\mathbf{V}_{\mathrm{C}}$ ) AND SUPPLY GROUND ( $\mathrm{V}_{\mathbf{S S}}$ )

The $\mathrm{V}_{\mathrm{CC}}$ pin is the system supply voltage. The $\mathrm{V}_{\mathrm{SS}}$ pin is the system ground.

## Analog Supply Voltages (V+ and V-)

These supplies are the analog voltage supplies for the potentiometer. The $\mathrm{V}+$ supply is tied to the wiper switches while the V-supply is used to bias the switches and the internal $P+$ substrate of the integrated circuit. Both of these supplies set the voltage limits of the potentiometer.

## Other Pins

## NO CONNECT

No connect pins should be left floating. This pins are used for Intersil manufacturing and testing purposes.

## HARDWARE WRITE PROTECT INPUT ( $\overline{\mathrm{WP}}$ )

The $\overline{\mathrm{WP}}$ pin when LOW prevents nonvolatile writes to the Data Registers.

## PRINCIPLES OF OPERATION

## Serial Interface

The X9260 supports the SPI interface hardware conventions. The device is accessed via the SI input with data clocked in on the rising SCK. $\overline{\mathrm{CS}}$ must be LOW and the $\overline{\text { HOLD and }} \overline{\mathrm{WP}}$ pins must be HIGH during the entire operation.

The SO and SI pins can be connected together, since they have three state outputs. This can help to reduce system pin count.

## Array Description

The X9260 is comprised of a resistor array (See Figure 1). The array contains the equivalent of 255 discrete resistive segments that are connected in series. The physical ends of each array are equivalent to the fixed terminals of a mechanical potentiometer ( $R_{H}$ and $R_{L}$ inputs).
At both ends of each array and between each resistor segment is a CMOS switch connected to the wiper ( $\mathrm{R}_{\mathrm{W}}$ ) output. Within each individual array only one switch may be turned on at a time.

These switches are controlled by a Wiper Counter Register (WCR). The 8-bits of the WCR (WCR[7:0]) are decoded to select, and enable, one of 256 switches (See Table 1).

## Power-up and Down Requirements.

At all times, the voltages on the potentiometer pins must be less than $\mathrm{V}+$ and more than V -. During powerup and power-down, VCC, $\mathrm{V}+$, and V - must reach their final values within 1 msecs of each other. The $\mathrm{V}_{\mathrm{CC}}$ ramp rate spec is always in effect.

Figure 1. Detailed Potentiometer Block Diagram


## DEVICE DESCRIPTION

## Wiper Counter Register (WCR)

The X9260 contains two Wiper Counter Registers, one for each DCP potentiometer. The Wiper Counter Register can be envisioned as a 8 -bit parallel and serial load counter with its outputs decoded to select one of 256 switches along its resistor array. The contents of the WCR can be altered in four ways: it may be written directly by the host via the Write Wiper Counter Register instruction (serial load); it may be written indirectly by transferring the contents of one of four associated data registers via the XFR Data Register instruction (parallel load); it can be modified one step at a time by the Increment/Decrement instruction (See Instruction section for more details). Finally, it is loaded with the contents of its Data Register zero (DRO) upon power-up.
The Wiper Counter Register is a volatile register; that is, its contents are lost when the X9260 is powereddown. Although the register is automatically loaded with the value in DRO upon power-up, this may be different from the value present at power-down. Power-up guidelines are recommended to ensure proper loadings of the DRO value into the WCR.

## Data Registers (DR)

Each potentiometer has four 8-bit nonvolatile Data Registers. These can be read or written directly by the host. Data can also be transferred between any of the four Data Registers and the associated Wiper Counter Register. All operations changing data in one of the Data Registers is a nonvolatile operation and will take a maximum of 10 ms .

If the application does not require storage of multiple settings for the potentiometer, the Data Registers can be used as regular memory locations for system parameters or user preference data.

Bits [7:0] are used to store one of the 256 wiper positions or data (0~255).

## Status Register (SR)

This 1-bit Status Register is used to store the system status.

WIP: Write In Progress status bit, read only.

- When WIP $=1$, indicates that high-voltage write cycle is in progress.
- When WIP $=0$, indicates that no high-voltage write cycle is in progress.

Table 5. Wiper Counter Register, WCR (8-bit), WCR[7:0]: Used to store the current wiper position (Volatile, V).

| WCR7 | WCR6 | WCR5 | WCR4 | WCR3 | WCR2 | WCR1 | WCR0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| V | V | V | V | V | V | V | V |
| (MSB) |  |  |  |  |  | (LSB) |  |

Table 5. Data Register, DR (8-bit), Bit [7:0]: Used to store wiper positions or data (Nonvolatile, NV).

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| NV | NV | NV | NV | NV | NV | NV | NV |
| MSB |  |  |  |  | LSB |  |  |

## DEVICE DESCRIPTION

## Instructions

## IDENTIFICATION BYTE (ID AND A )

The first byte sent to the X9260 from the host, following a $\overline{\mathrm{CS}}$ going HIGH to LOW, is called the Identification Byte. The most significant four bits of the slave address are a device type identifier. The ID[3:0] bits is the device id for the X9260; this is fixed as 0101[B] (refer to Table 3).

The $A D[3: 0]$ bits in the ID byte is the internal slave address. The physical device address is defined by the state of the A3-A0 input pins. The slave address is externally specified by the user. The X9260 compares the serial data stream with the address input state; a successful compare of both address bits is required for the X9260 to successfully continue the
command sequence. Only the device which slave address matches the incoming device address sent by the master executes the instruction. The A3-A0 inputs can be actively driven by CMOS input signals or tied to $\mathrm{V}_{\mathrm{CC}}$ or $\mathrm{V}_{\mathrm{SS}}$.

## INSTRUCTION BYTE ( I[3:0] )

The next byte sent to the X9260 contains the instruction and register pointer information. The three most significant bits are used provide the instruction opcode (I[3:0]). The RB and RA bits point to one of the four Data Registers of each associated XDCP. The least significant bit points to one of two Wiper Counter Registers or Pots. The format is shown below in Table 4.

Table 3. Identification Byte Format

| ID3 | ID2 | ID1 | ID0 | A3 | A2 | A1 | A0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Device Type <br> Identifier |  |  |  |  |  |  |  |
| (MSB) |  |  |  |  |  |  |  |

Table 4. Instruction Byte Format


## DEVICE DESCRIPTION

## Instructions

Four of the ten instructions are three bytes in length. These instructions are:

- Read Wiper Counter Register - read the current wiper position of the selected potentiometer,
- Write Wiper Counter Register - change current wiper position of the selected potentiometer,
- Read Data Register - read the contents of the selected Data Register;
- Write Data Register - write a new value to the selected Data Register.
- Read Status - This command returns the contents of the WIP bit which indicates if the internal write cycle is in progress.
The basic sequence of the three byte instructions is illustrated in Figure 3. These three-byte instructions exchange data between the WCR and one of the Data Registers. A transfer from a Data Register to a WCR is essentially a write to a static RAM, with the static RAM controlling the wiper position. The response of the wiper to this action will be delayed by twRL. A transfer from the WCR (current wiper position), to a Data Register is a write to nonvolatile memory and takes a minimum of twR to complete. The transfer can occur between one of the two potentiometers and one of its associated registers; or it may occur globally, where the transfer occurs between all potentiometers and one associated register. The Read Status Register instruction is the only unique format (See Figure 5).

Four instructions require a two-byte sequence to complete. These instructions transfer data between the host and the X9260; either between the host and one of the data registers or directly between the host and the Wiper Counter Register. These instructions are:

- XFR Data Register to Wiper Counter Register This transfers the contents of one specified Data Register to the associated Wiper Counter Register.
- XFR Wiper Counter Register to Data Register This transfers the contents of the specified Wiper Counter Register to the specified associated Data Register.
- Global XFR Data Register to Wiper Counter Register - This transfers the contents of all specified Data Registers to the associated Wiper Counter Registers.
- Global XFR Wiper Counter Register to Data Register - This transfers the contents of all Wiper Counter Registers to the specified associated Data Registers.


## INCREMENT/DECREMENT COMMAND

The final command is Increment/Decrement (See Figures 6 and 7). The Increment/Decrement command is different from the other commands. Once the command is issued and the X9260 has responded with an acknowledge, the master can clock the selected wiper up and/or down in one segment steps; thereby, providing a fine tuning capability to the host. For each SCL clock pulse ( $\mathrm{t}_{\text {HIGH }}$ ) while SI is HIGH, the selected wiper will move one resistor segment towards the $\mathrm{R}_{\mathrm{H}}$ terminal. Similarly, for each SCL clock pulse while SI is LOW, the selected wiper will move one resistor segment towards the $R_{L}$ terminal. A detailed illustration of the sequence and timing for this operation are shown. See Instruction format for more details.

Figure 2. Two-Byte Instruction Sequence


Figure 3. Three-Byte Instruction Sequence (Write)


Figure 4. Three-Byte Instruction Sequence (Read)


Figure 5. Three-Byte Instruction Sequence (Read Status Register)


Figure 6. Increment/Decrement Instruction Sequence


Figure 7. Increment/Decrement Timing Limits


Table 5. Instruction Set

| Instruction | Instruction Set |  |  |  |  |  |  |  | Operation |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 13 | 12 | 11 | 10 | RB | RA | 0 | P0 |  |
| Read Wiper Counter Register | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 1/0 | Read the contents of the Wiper Counter Register pointed to by P0 |
| Write Wiper Counter Register | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 1/0 | Write new value to the Wiper Counter Register pointed to by P0 |
| Read Data Register | 1 | 0 | 1 | 1 | 1/0 | 1/0 | 0 | 1/0 | Read the contents of the Data Register pointed to by P0 and RB - RA |
| Write Data Register | 1 | 1 | 0 | 0 | 1/0 | 1/0 | 0 | 1/0 | Write new value to the Data Register pointed to by P0 and RB - RA |
| XFR Data Register to Wiper Counter Register | 1 | 1 | 0 | 1 | 1/0 | 1/0 | 0 | 1/0 | Transfer the contents of the Data Register pointed to by P0 and RB - RA to its associated Wiper Counter Register |
| XFR Wiper Counter Register to Data Register | 1 | 1 | 1 | 0 | 1/0 | 1/0 | 0 | 1/0 | Transfer the contents of the Wiper Counter Register pointed to by P0 to the Data Register pointed to by RB - RA |
| Global XFR Data Registers to Wiper Counter Registers | 0 | 0 | 0 | 1 | 1/0 | 1/0 | 0 | 0 | Transfer the contents of the Data Registers pointed to by RB - RA of all four pots to their respective Wiper Counter Registers |
| Global XFR Wiper Counter Registers to Data Register | 1 | 0 | 0 | 0 | 1/0 | 1/0 | 0 | 0 | Transfer the contents of both Wiper Counter Registers to their respective data Registers pointed to by RB - RA of all four pots |
| Increment/Decrement Wiper Counter Register | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 1/0 | Enable Increment/decrement of the Control Latch pointed to by P0 |

Note: $\quad 1 / 0=$ data is one or zero

## INSTRUCTION FORMAT

## Read Wiper Counter Register (WCR)

\begin{tabular}{|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|c|}
\hline \& \multicolumn{4}{|l|}{Device Type Identifier} \& \multicolumn{4}{|r|}{Device Addresses} \& \multicolumn{4}{|r|}{Instruction Opcode} \& \multicolumn{4}{|r|}{\begin{tabular}{l}
WCR \\
Addresses
\end{tabular}} \& \multicolumn{8}{|l|}{Wiper Position (Sent by X9260 on SO)} \& \multirow[b]{2}{*}{\begin{tabular}{l}
\(\overline{C S}\) \\
Rising Edge
\end{tabular}} \\
\hline Falling Edge \& 0 \& 1 \& 0 \& 1 \& 0 \& 0 \& A1 \& A0 \& 1 \& 0 \& 0 \& 1 \& 0 \& 0 \& 0 \& P0 \& W
\(C\)
\(R\)
7 \& \begin{tabular}{l} 
W \\
\(C\) \\
\(R\) \\
R \\
\\
\hline
\end{tabular} \& W
\(C\)
\(R\)
S \& W
C
R
4 \& W
\(C\)
\(R\)

3 \& W
$C$
$R$
2 \& W
$C$
$R$
1 \& W
$C$
$R$
0 \& <br>
\hline
\end{tabular}

## Write Wiper Counter Register (WCR)

| $\overline{\mathrm{CS}}$ <br> Falling Edge | Device Type Identifier |  |  |  | Device <br> Addresses |  |  |  | Instruction Opcode |  |  |  | WCR <br> Addresses |  |  |  | Data Byte (Sent by Host on SI) |  |  |  |  |  |  |  | $\overline{C S}$ <br> Rising Edge |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | 0 | 1 | 0 | 1 | 0 | 0 | A1 | A0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | P0 | C $R$ 7 | W $C$ $R$ 6 | W <br> $C$ <br> $R$ <br> 5 | W $C$ $R$ 4 | W $C$ $R$ 3 | W <br> $C$ <br> $R$ <br> R <br> 2 | W | W C R 0 |  |

## Read Data Register (DR)

| $\overline{\mathrm{CS}}$ | Device Type Identifier |  |  |  | Device Addresses |  |  |  | Instruction Opcode |  |  |  | DR and WCR Addresses |  |  |  | Data Byte <br> (Sent by X9271 on SO) |  |  |  |  |  |  |  | $\overline{\mathrm{CS}}$ <br> Rising Edge |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Falling Edge | 0 | 1 | 0 | 1 | 0 | 0 | A1 | A0 | 1 | 0 | 1 | 1 | RB | RA | 0 | P0 | D | D | D | D | D | D | D | D |  |

## Write Data Register (DR)

|  | Device Type Identifier |  |  |  | Device Addresses |  |  |  | Instruction Opcode |  |  |  | DR and WCR <br> Addresses |  |  |  | Data Byte (Sent by Host on SI) |  |  |  |  |  |  |  | $\overline{\mathrm{CS}}$ <br> Rising <br> Edge |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Falling Edge | 0 | 1 | 0 | 1 | 0 | 0 | A1 | A0 | 1 | 1 | 0 | 0 | RB | RA | 0 | P0 | $\begin{aligned} & \mathrm{D} \\ & 7 \end{aligned}$ | $\begin{aligned} & D \\ & 6 \end{aligned}$ | $\begin{aligned} & D \\ & 5 \end{aligned}$ | $\begin{aligned} & \mathrm{D} \\ & 4 \end{aligned}$ | $\begin{aligned} & \mathrm{D} \\ & 3 \end{aligned}$ | $\begin{aligned} & \mathrm{D} \\ & 2 \end{aligned}$ | $\begin{aligned} & \mathrm{D} \\ & 1 \end{aligned}$ | D |  |  |

Global Transfer Data Register (DR) to Wiper Counter Register (WCR)

| Falling | Device Type Identifier |  |  |  | Device Addresses |  |  |  | Instruction Opcode |  |  |  | $\overline{\mathrm{DR}}$ <br> Addresses |  |  |  | $\overline{\mathrm{CS}}$ <br> Rising Edge |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Edge | 0 | 1 | 0 | 1 | 0 | 0 | A1 | A0 | 0 |  | 0 | 1 | RB | RA | 0 |  |  |

Global Transfer Wiper Counter Register (WCR) to Data Register (DR)

| $\overline{\mathrm{CS}}$ <br> Falling | Device Type Identifier |  |  |  | Device Addresses |  |  |  | Instruction Opcode |  |  |  | DR <br> Addresses |  |  |  | $\overline{\mathrm{CS}}$ <br> Rising Edge | HIGH-VOLTAGE WRITE CYCLE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Edge | 0 | 1 | 0 | 1 | 0 | 0 | A1 | A0 | 1 | 0 | 0 | 0 | RB | RA | 0 | 0 |  |  |

## Transfer Wiper Counter Register (WCR) to Data <br> Register (DR)

| Falling | Device Type Identifier |  |  |  | Device <br> Addresses |  |  |  | nstruction Opcode |  |  |  | DR and WCR <br> Addresses |  |  |  | $\overline{\mathrm{CS}}$ <br> Rising Edge | IIGH-VOLTAGE WRITE CYCLE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Edge | 0 | 1 | 0 | 1 | 0 |  | A1 | A0 | 1 | 1 | 1 | 0 | RB | RA | 0 | P0 |  |  |

## Transfer Data Register (DR) to Wiper Counter Register (WCR)

|  | Identifier |  |  |  | Device <br> Addresses |  |  |  | Opcode |  |  |  | DR and WCR <br> Addresses |  |  |  | $\overline{\mathrm{CS}}$ <br> Rising Edge |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Edge | 0 | 1 | 0 | 1 | 0 | 0 | A1 | A | 1 | 1 | 0 | 1 | RB | RA | 0 |  |  |

## Increment/Decrement Wiper Counter Register


(WCR)
Read Status Register (SR)

| Falling | Device Type Identifier |  |  |  | Device <br> Addresses |  |  |  | Opcode |  |  |  | WCR <br> Addresses |  |  |  | Data Byte(Sent by X9260 on SO) |  |  |  |  |  |  |  | CS <br> Rising <br> Edge |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Edge | 0 | 1 | 0 | 1 | 0 | 0 | A1 | A0 | 0 |  | 0 | 1 | 0 | 0 | 0 | 1 |  | 0 | 0 | 0 | 0 | 0 | 0 | WIP |  |

Notes: (1) "A1 ~ A0": stands for the device addresses sent by the master.
(2) WPx refers to wiper position data in the Counter Register
(2) "l": stands for the increment operation, SI held HIGH during active SCK phase (high).
(3) "D": stands for the decrement operation, SI held LOW during active SCK phase (high).

## ABSOLUTE MAXIMUM RATINGS

Temperature under bias $\qquad$ -65 to $+135^{\circ} \mathrm{C}$
Storage temperature -65 to $+150^{\circ} \mathrm{C}$
Voltage on SCK, SCL or any address input with respect to $\mathrm{V}_{\mathrm{SS}}$ -1 V to +7 V
Voltage on $\mathrm{V}+\left(\right.$ referenced to $\left.\mathrm{V}_{\mathrm{SS}}\right)$....................... 10 V
Voltage on V - (referenced to $\mathrm{V}_{\mathrm{SS}}$ ).......................-10V
(V+) - (V-)12V
Any $\mathrm{V}_{\mathrm{H}} / \mathrm{R}_{\mathrm{H}}$ ..... V+
Any $\mathrm{V}_{\mathrm{L}} / \mathrm{R}_{\mathrm{L}}$ ..... V-
Lead temperature (soldering, 10 seconds) ..... $+300^{\circ} \mathrm{C}$
IW (10 seconds) ..... $\pm 6 \mathrm{~mA}$

## RECOMMENDED OPERATING CONDITIONS

| Temp | Min. | Max. |
| :---: | :---: | :---: |
| Commercial | $0^{\circ} \mathrm{C}$ | $+70^{\circ} \mathrm{C}$ |
| Industrial | $-40^{\circ} \mathrm{C}$ | $+85^{\circ} \mathrm{C}$ |

## COMMENT

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; the functional operation of the device (at these or any other conditions above those listed in the operational sections of this specification) is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

| Device | Supply Voltage $\mathbf{( V}_{\mathbf{C C}} \mathbf{)}^{(4)}$ Limits |
| :---: | :---: |
| X 9260 | $5 \mathrm{~V} \pm 10 \%$ |
| $\mathrm{X} 9260-2.7$ | 2.7 V to 5.5 V |


| $\mathrm{V}+$ | 2.7 V to 5.5 V |
| :---: | :---: |
| $\mathrm{~V}-$ | -2.5 V to -5.5 V |

POTENTIOMETER CHARACTERISTICS (Over recommended operating conditions unless otherwise stated.)

| Symbol | Parameter |  |  |  |  |  | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Unit |  |
|  | End to end resistance |  |  |  | $\pm 20$ | \% |  |
|  | Power rating |  |  |  | 50 | mW | $25^{\circ} \mathrm{C}$, each pot |
| IW | Wiper current |  |  |  | $\pm 3$ | mA |  |
| $\mathrm{R}_{\mathrm{W}}$ | Wiper resistance |  |  |  | 250 | $\Omega$ | $\begin{aligned} & \text { Wiper current }= \pm 1 \mathrm{~mA} \text {, } \\ & \mathrm{V}+=3 \mathrm{~V} ; \mathrm{V}-=-3 \mathrm{~V} \end{aligned}$ |
| $\mathrm{R}_{\mathrm{W}}$ | Wiper resistance |  |  |  | 150 | $\Omega$ | $\begin{aligned} & \text { Wiper current }= \pm 1 \mathrm{~mA} \text {, } \\ & \mathrm{V}+=3 \mathrm{~V} ; \mathrm{V}-=-3 \mathrm{~V} \end{aligned}$ |
| Vv+ | Voltage on V+pin | X9260 | +4.5 |  | +5.5 | V |  |
|  |  | X9260-2.7 | +2.7 |  | +5.5 |  |  |
| Vv- | Voltage on V-pin | X9260 | -5.5 |  | -4.5 | V |  |
|  |  | X9260-2.7 | -5.5 |  | -2.7 |  |  |
| $\mathrm{V}_{\text {TERM }}$ | Voltage on any $\mathrm{V}_{\mathrm{H}} / \mathrm{R}_{\mathrm{H}}$ or $\mathrm{V}_{\mathrm{L}} / \mathrm{R}_{\mathrm{L}}$ pin |  | V- |  | V+ | V |  |
|  | Noise |  |  | -120 |  | dBV | Ref: 1kHz |
|  | Resolution ${ }^{(4)}$ |  |  | 0.4 |  | \% |  |
|  | Absolute linearity ${ }^{(1)}$ |  |  |  | $\pm 1$ | $\mathrm{Ml}^{(3)}$ | $\mathrm{V}_{\mathrm{w}(\mathrm{n}) \text { (actual) }}-\mathrm{V}_{\mathrm{w}(\mathrm{n}) \text { (expected) }}$ |
|  | Relative linearity ${ }^{(2)}$ |  |  |  | $\pm 0.6$ | $\mathrm{MI}^{(3)}$ | $\mathrm{V}_{\mathrm{W}(\mathrm{n}+1)}-\left[\mathrm{V}_{\mathrm{w}(\mathrm{n})+\mathrm{MI}}\right]$ |
|  | Temperature coefficient |  |  | $\pm 300$ |  | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |  |
|  | Ratiometric Temperature Coefficient |  |  |  | $\pm 20$ | ppm/ ${ }^{\circ} \mathrm{C}$ |  |
| $\mathrm{C}_{\mathrm{H}} / \mathrm{C}_{\mathrm{L}} / \mathrm{C}_{\mathrm{W}}$ | Potentiometer Capacitances |  |  | 10/10/25 |  | pF | See Circuit \#3 |

Notes: (1) Absolute linearity is utilized to determine actual wiper voltage versus expected voltage as determined by wiper position when used as a potentiometer.
(2) Relative linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.
(3) $\mathrm{MI}=\mathrm{RTOT} / 255$ or $\left(\mathrm{R}_{\mathrm{H}}-\mathrm{R}_{\mathrm{L}}\right) / 255$, single pot
(4) During power-up $\mathrm{V}_{\mathrm{C}}>\mathrm{V}_{\mathrm{H}}, \mathrm{V}_{\mathrm{L}}$, and $\mathrm{V}_{\mathrm{W}}$.
(5) $n=0,1,2, \ldots, 255 ; m=0,1,2, \ldots, 254$.
D.C. OPERATING CHARACTERISTICS (Over the recommended operating conditions unless otherwise specified.)

| Symbol | Parameter |  |  |  | Limits |  |  |  | Test Conditions |
| :--- | :--- | :---: | :---: | :---: | :---: | :--- | :---: | :---: | :---: |

## ENDURANCE AND DATA RETENTION

| Parameter | Min. | Units |
| :---: | :---: | :---: |
| Minimum endurance | 100,000 | Data changes per bit per register |
| Data retention | 100 | years |

## CAPACITANCE

| Symbol | Test | Max. | Units | Test Conditions |
| :--- | :--- | :---: | :---: | :---: |
| $\mathrm{C}_{\mathrm{OUT}}{ }^{(6)}$ | Output capacitance (SO) | 8 | pF | $\mathrm{V}_{\mathrm{OUT}}=0 \mathrm{~V}$ |
| $\mathrm{C}_{\mathrm{IN}}{ }^{(6)}$ | Input capacitance $(\mathrm{AO}, \mathrm{A} 1, \mathrm{SI}, \overline{\mathrm{CS}}, \overline{\mathrm{WP}}, \overline{\mathrm{HOLD}}$, and SCK $)$ | 6 | pF | $\mathrm{V}_{\mathrm{IN}}=0 \mathrm{~V}$ |

## POWER-UP TIMING

| Symbol | Parameter | Min. | Max. | Units |
| :--- | :--- | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{r}} \mathrm{V}_{\mathrm{CC}}{ }^{(6)}$ | $\mathrm{V}_{\mathrm{CC}}$ Power-up rate | 0.2 | 50 | $\mathrm{~V} / \mathrm{ms}$ |
| tpur $^{(7)}$ | Power-up to initiation of read operation |  | 1 | ms |

## POWER-UP AND DOWN REQUIREMENTS

The are no restrictions on the sequencing of the bias supplies $\mathrm{V}_{\mathrm{CC}}, \mathrm{V}+$, and V - provided that all three supplies reach their final values within 1 msec of each other. At all times, the voltages on the potentiometer pins must be less than $\mathrm{V}_{+}$ and more than V -. The recall of the wiper position from nonvolatile memory is not in effect until all supplies reach their final value. The $V_{C C}$ ramp rate spec is always in effect.

## A.C. TEST CONDITIONS

| Input Pulse Levels | $\mathrm{V}_{\mathrm{CC}} \times 0.1$ to $\mathrm{V}_{\mathrm{CC}} \times 0.9$ |
| :---: | :---: |
| Input rise and fall times | 10 ns |
| Input and output timing level | $\mathrm{V}_{\mathrm{CC}} \times 0.5$ |

Notes: (6) This parameter is not $100 \%$ tested
(7) tPUR and tPUW are the delays required from the time the (last) power supply $\left(\mathrm{V}_{\mathrm{CC}}-\right.$ ) is stable until the specific instruction can be issued. These parameters are not $100 \%$ tested.

EQUIVALENT A.C. LOAD CIRCUIT



AC TIMING

| Symbol | Parameter | Min. | Max. | Units |
| :---: | :---: | :---: | :---: | :---: |
| fSCK | SSI/SPI clock frequency |  | 2 | MHz |
| ${ }^{\text {t }}$ CYC | SSI/SPI clock cycle rime | 500 |  | ns |
| $\mathrm{t}_{\text {WH }}$ | SSI/SPI clock high rime | 200 |  | ns |
| $t_{\text {WL }}$ | SSI/SPI clock low time | 200 |  | ns |
| t LEAD | Lead time | 250 |  | ns |
| tLAG | Lag time | 250 |  | ns |
| tSU | SI, SCK, $\overline{\text { HOLD }}$ and $\overline{\mathrm{CS}}$ input setup time | 50 |  | ns |
| $\mathrm{t}_{\mathrm{H}}$ | SI, SCK, $\overline{\mathrm{HOLD}}$ and $\overline{\mathrm{CS}}$ input hold time | 50 |  | ns |
| $\mathrm{t}_{\mathrm{RI}}$ | SI, SCK, $\overline{\mathrm{HOLD}}$ and $\overline{\mathrm{CS}}$ input rise time |  | 2 | $\mu \mathrm{S}$ |
| $\mathrm{t}_{\mathrm{Fl}}$ | SI, SCK, $\overline{\text { HOLD }}$ and $\overline{\mathrm{CS}}$ input fall time |  | 2 | $\mu \mathrm{s}$ |
| $\mathrm{t}_{\text {DIS }}$ | SO output disable time | 0 | 250 | ns |
| $\mathrm{t}_{\mathrm{V}}$ | SO output valid time |  | 200 | ns |
| $\mathrm{t}_{\mathrm{HO}}$ | SO output hold time | 0 |  | ns |
| $\mathrm{t}_{\mathrm{RO}}$ | SO output rise time |  | 100 | ns |
| $\mathrm{t}_{\mathrm{FO}}$ | SO output fall time |  | 100 | ns |
| $\mathrm{t}_{\text {HOLD }}$ | $\overline{\text { HOLD time }}$ | 400 |  | ns |
| $\mathrm{t}_{\mathrm{HSU}}$ | $\overline{\text { HOLD setup time }}$ | 100 |  | ns |
| $\mathrm{t}_{\mathrm{HH}}$ | HOLD hold time | 100 |  | ns |
| $\mathrm{t}_{\mathrm{HZ}}$ | $\overline{\text { HOLD }}$ low to output in high Z |  | 100 | ns |
| tLZ | $\overline{\text { HOLD }}$ high to output in low Z |  | 100 | ns |
| $\mathrm{T}_{1}$ | Noise suppression time constant at SI, SCK, $\overline{\text { HOLD }}$ and $\overline{\mathrm{CS}}$ inputs |  | 10 | ns |
| tcs | $\overline{\mathrm{CS}}$ deselect time | 2 |  | $\mu \mathrm{s}$ |
| tWPASU | $\overline{\mathrm{WP}}, \mathrm{A} 0$ setup time | 0 |  | ns |
| $t_{\text {WPAH }}$ | $\overline{\mathrm{WP}}, \mathrm{A} 0$ hold time | 0 |  | ns |

HIGH-VOLTAGE WRITE CYCLE TIMING

| Symbol | Parameter | Typ. | Max. | Units |
| :--- | :--- | :---: | :---: | :---: |
| $\mathrm{t}_{\mathrm{WR}}$ | High-voltage write cycle time (store instructions) | 5 | 10 | ms |

## XDCP TIMING

| Symbol | Parameter | Min. | Max. | Units |
| :--- | :--- | :---: | :---: | :---: |
| tWRPO | Wiper response time after the third (last) power supply is stable | 5 | 10 | $\mu \mathrm{~s}$ |
| tWRL | Wiper response time after instruction issued (all load instructions) | 5 | 10 | $\mu \mathrm{~s}$ |

## SYMBOL TABLE

$\left.\begin{array}{lll}\text { WAVEFORM } & \text { INPUTS } & \text { OUTPUTS } \\ & \begin{array}{l}\text { Must be } \\ \text { steady }\end{array} & \begin{array}{l}\text { Will be } \\ \text { steady }\end{array} \\ \text { May change } \\ \text { from Low to } \\ \text { High }\end{array} \begin{array}{l}\text { Will change } \\ \text { from Low to } \\ \text { High }\end{array}\right\}$

## TIMING DIAGRAMS

## Input Timing



## Output Timing



Hold Timing


## XDCP Timing (for All Load Instructions)



## Write Protect and Device Address Pins Timing



## APPLICATIONS INFORMATION

## Basic Configurations of Electronic Potentiometers



THREE- TERMINAL POTENTIOMETER; VARIABLE VOLTAGE DIVIDER


TWO-TERMINAL VARIABLE RESISTOR; VARIABLE CURRENT

## Application Circuits

NONINVERTING AMPLIFIER


OFFSET VOLTAGE ADJUSTMENT


VOLTAGE REGULATOR


COMPARATOR WITH HYSTERISIS

$\mathrm{V}_{\mathrm{UL}}=\left\{\mathrm{R}_{1} /\left(\mathrm{R}_{1}+\mathrm{R}_{2}\right)\right\} \mathrm{V}_{\mathrm{O}}(\max )$
$\mathrm{V}_{\mathrm{LL}}=\left\{\mathrm{R}_{1} /\left(\mathrm{R}_{1}+\mathrm{R}_{2}\right)\right\} \mathrm{V}_{\mathrm{O}}($ min $)$

## Application Circuits (continued)



## INVERTING AMPLIFIER


$V_{O}=G V_{S}$
$G=-R_{2} / R_{1}$

FILTER

$\mathrm{G}_{\mathrm{O}}=1+\mathrm{R}_{2} / \mathrm{R}_{1}$ fc $=1 /(2 \pi R C)$

EQUIVALENT L-R CIRCUIT


$$
Z_{I N}=R_{2}+s R_{2}\left(R_{1}+R_{3}\right) C_{1}=R_{2}+s \text { Leq }
$$

$$
\left(R_{1}+R_{3}\right) \gg R_{2}
$$

FUNCTION GENERATOR

frequency $\propto R_{1}, R_{2}, C$ amplitude $\propto R_{A}, R_{B}$

## Small Outline Plastic Packages (SOIC)



NOTES:

1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension " D " does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15 mm (0.006 inch) per side.
4. Dimension " $E$ " does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25 mm ( 0.010 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. " L " is the length of terminal for soldering to a substrate.
7. " N " is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. The lead width " $B$ ", as measured 0.36 mm ( 0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61 mm ( 0.024 inch )
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

M24.3 (JEDEC MS-013-AD ISSUE C) 24 LEAD WIDE BODY SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL | INCHES |  | MILLIMETERS |  |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |  |  |  |  |  |  |
| A | 0.0926 | 0.1043 | 2.35 | 2.65 | - |  |  |  |  |  |  |
| A1 | 0.0040 | 0.0118 | 0.10 | 0.30 | - |  |  |  |  |  |  |
| B | 0.013 | 0.020 | 0.33 | 0.51 | 9 |  |  |  |  |  |  |
| C | 0.0091 | 0.0125 | 0.23 | 0.32 | - |  |  |  |  |  |  |
| D | 0.5985 | 0.6141 | 15.20 | 15.60 | 3 |  |  |  |  |  |  |
| E | 0.2914 | 0.2992 | 7.40 | 7.60 | 4 |  |  |  |  |  |  |
| e | 0.05 |  | BSC | 1.27 |  |  |  |  |  |  |  |
| HSC | - |  |  |  |  |  |  |  |  |  |  |
| h | 0.394 | 0.419 | 10.00 | 10.65 | - |  |  |  |  |  |  |
| L | 0.010 | 0.029 | 0.25 | 0.75 | 5 |  |  |  |  |  |  |
| N | 24 |  |  |  |  |  |  | 0.050 | 0.40 | 1.27 | 6 |
| $\alpha$ | $0^{\circ}$ | $8^{\circ}$ | $0^{\circ}$ |  | $8^{\circ}$ |  |  |  |  |  |  |

Rev. 1 4/06

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